



SPECIFICATION

Customer : DIGI-KEY ELECTRONICS.

Item:	Crystal Unit
Type:	NX3225GD
Nominal Frequency:	8.000 MHz
Customer's Spec. No.:	---
NDK Spec. No.:	EXS00A-CG04874

Receipt

Revision Record						
Rev.	Date	Items	Contents	Approved	Checked	Drawn
---	14. Feb. 2024	Issue	---	M.Sato	M.Harada	H.Arimi

1. Customer's Spec. No. : ---
2. NDK Spec. No. : EXS00A-CG04874
3. Type : NX3225GD

4. Electrical Specifications

	Parameters	SYM.	Electrical Spec.				Notes
			min	typ	max	Units	
1	Nominal frequency	f_{nom}	8.000			MHz	
2	Overtone order	-	Fundamental			-	
3	Frequency tolerance	-	-20	-	+20	$\times 10^{-6}$	at +25°C
4	Frequency versus temperature characteristics	-	-50	-	+50	$\times 10^{-6}$	at -40~+85°C The reference temperature shall be +25°C
5	Equivalent resistance	-	-	-	500	Ω	IEC PI-network/Series
6	Shunt capacitance	C_0	-30%	1.08	+30%	pF	Not grounded
7	Motional capacitance	C_1	-30%	1.11	+30%	fF	Not grounded
8	Motional inductance	L_1	-30%	356	+30%	mH	Not grounded
9	Load capacitance	C_L	-	8	-	pF	IEC PI-network
10	Level of drive	-	-	10	200	μ W	
11	Operating temperature range	T_{opr}	-40	-	+85	°C	
12	Storage temperature range	T_{str}	-40	-	+150	°C	
13	Insulation resistance	-	500	-	-	M Ω	When terminal to terminal and terminal to cover were applied at DC100V \pm 15V.
14	Air-tightness	-	-	-	3.0×10^{-9}	Pa m ³ /s	

5. Examination results document

The examination results document is submitted every shipment lot.

6. Application drawing

- 6.1 External dimension : EXD14B-00474
- 6.2 Taping and reel figure : EXK17B-00247
- 6.3 Holder marking : EXH11B-00392
- 6.4 Reliability assurance Item : EXS30B-00821
- 6.5 Recommendation reflow profile : EXS30B-00344

7. Notes on use

7-1 Even if the appearance color etc. of the product differs by purchasing the component parts by more than two companies, there is no influence on the characteristics and reliability.

7-2 Since the crystal unit is a passive component, it is important to have appropriate circuit conditions.

Please be sure to check the circuit conditions before using the crystal units, and ensure the necessary circuit margin, and confirm that the desired frequency is output. Moreover, please check the circuit conditions when using an existing crystal unit for another model or board.

If the circuit conditions are not appropriate, there is a risk of oscillation stop or frequency deviation.

7-3 IN THE CASE OF THE FOLLOWING ITEMS, WE ARE NOT RESPONSIBLE FOR WARRANTY / COMPENSATION.

(1) WHEN PRODUCTS OF THIS SPECIFICATION ARE USED FOR EQUIPMENT RELATED TO HUMAN LIFE OR PROPERTY, IT IS THE RESPONSIBILITY OF THE CUSTOMER TO CONFIRM THE INFLUENCE ON THIS PRODUCT AND EQUIPMENT TO BE USED BEFOREHAND, CONDUCT NECESSARY SAFETY DESIGN (INCLUDING REDUNDANT DESIGN, MALFUNCTION PREVENTION DESIGN, etc.), AND PLEASE USE IT AFTER SECURING SUFFICIENT SAFETY OF EQUIPMENT.

1. SAFETY-RELATED EQUIPMENT SUCH AS AUTOMOBILES, TRAINS, SHIPS, etc., OR EQUIPMENT DIRECTLY INVOLVED IN OPERATION

2. AIRCRAFT EQUIPMENT

3. SPACE EQUIPMENT

4. MEDICAL EQUIPMENT

5. MILITARY EQUIPMENT

6. DISASTER PREVENTION / CRIME PREVENTION EQUIPMENT

7. TRAFFIC LIGHT

8. OTHER EQUIPMENT REQUIRING THE SAME PERFORMANCE AS THE ABOVE-MENTIONED EQUIPMENT

(2) IN CASES WHERE IT IS NOT INDICATED IN THE REQUESTED STANDARD AND IS USED UNDER CONDITIONS OF USE (INCLUDING CIRCUIT MARGIN etc.) THAT CAN NOT BE PREDICTED AT THE PRODUCTION STAGE.

(3) WHEN USING ULTRASONIC WELDING MACHINE. (THERE IS A POSSIBILITY THAT THE CHARACTERISTIC DEGRADATION IS CAUSED BY THE RESONANCE PHENOMENON OF THE PIEZOELECTRIC MATERIAL.

(EXAMPLE; CRYSTAL PIECE))

WE WILL NOT TAKE ANY RESPONSIBILITY FOR THE INFLUENCE OF THE CUSTOMERS' PROCESS.

SO, PLEASE SUFFICIENTLY EVALUATE AT A SAMPLE STEP WHEN YOU USE ULTRASONIC WELDING MACHINE.

(4) USING RESIN MOLD MAY AFFECT THE PRODUCT CHARACTERISTIC.

PLEASE MAKE SURE TO TELL OUR SALES CONTACT WHEN YOU USE RESIN MOLD. WE WILL PERFORM INDIVIDUAL CORRESPONDENCE ABOUT A DELIVERY SPECIFICATION AND AN EVALUATION METHOD.

IN ADDITION, IF YOU USE RESIN MOLD WITHOUT CONTACTING US, AND CAUSES DAMAGES AGAINST A CUSTOMER OR A THIRD PARTY, WE WILL NOT BE LIABLE FOR THE DAMAGES AND OTHER RESPONSIBILITIES BECAUSE WE CONSIDER IT IS UNDER SELF-RESPONSIBILITY USING RESIN MOLD.

WE WILL NOT TAKE ANY RESPONSIBILITY FOR THE INFLUENCE OF THE CUSTOMERS' PROCESS. PLEASE SUFFICIENTLY EVALUATE AT A SAMPLE STEP WHEN YOU USE RESIN MOLD.

(5) WHEN PERFORMING IMPROPER HANDLING THAT EXCEEDS THE GUARANTEED RANGE.

8. Notes on storage

- 8-1 When storing the product in high temperature and high humidity condition for a long time, product characteristics (solderability etc.) and packaging condition may be deteriorated. Please store product at temperature + 5°C ~ + 35°C, humidity 85% RH or less. The product is an electronic component, so please do not storage and use, under a dewing state.
- 8-2 The product storage deadline is 12 months after delivery in unopened state. Please use within storage deadline. If you exceed storage deadline, please check the product characteristics etc, please use.

9. Other Requests

- 9-1 Please use this specification only for confirmation of the specification of this product.
- 9-2 If there is a change request, please contact within three weeks from issue date. If there is no communication, we will deliver the product under the contents of this specification. In addition, if the product delivery date is within 3 weeks and there is a change request, we will consult the processing separately.
- 9-3 NOTES THAT ARE DESCRIBED IN THIS DOCUMENT, IF YOU DID NOT COMPLY WITH THE PROHIBITIONS, AND OTHER PLEASE, INCLUDING THE FAILURE CORRESPONDENCE OR COMPENSATION OR DAMAGES, WE CAN NOT ASSUME THE RESPONSIBILITY, PLEASE UNDERSTAND.

10. Prohibited items

Be sure to use the product under the following conditions. Otherwise, the characteristics deterioration or destruction of the product may result.

(1) Reflow soldering heat resistance

Peak temperature: 265°C, 10 sec

Heating: 230°C or higher, 40 sec

Preheating: 150°C to 180°C, 120 sec

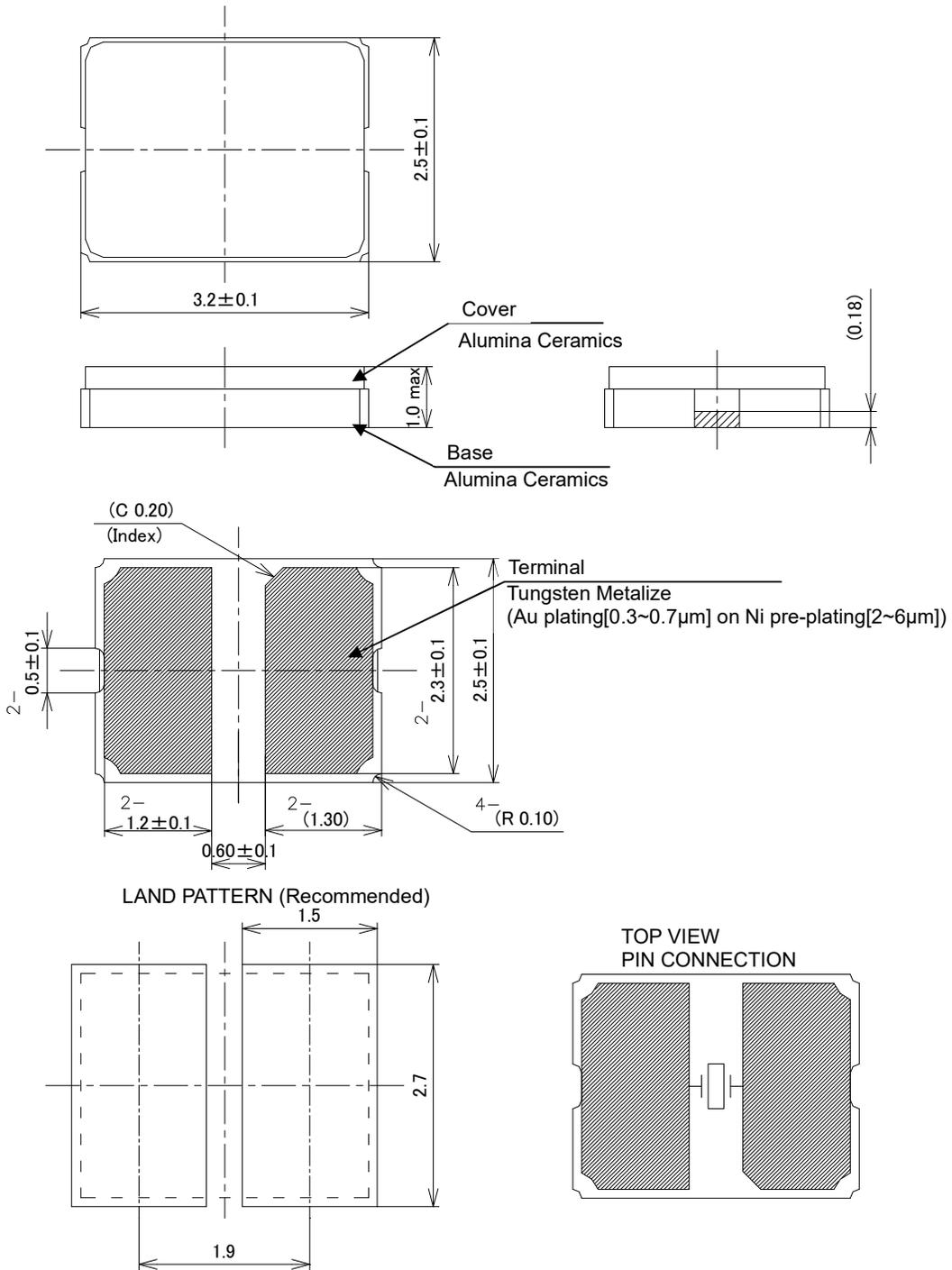
Reflow passage times: twice

(2) Manual soldering heat resistance

Pressing a soldering iron of 400°C on the terminal electrode for four seconds (twice).

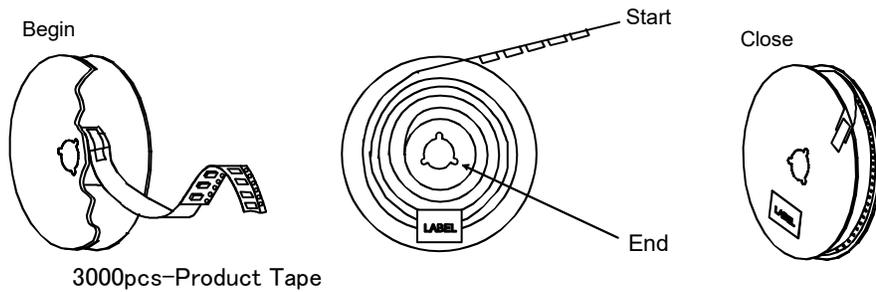
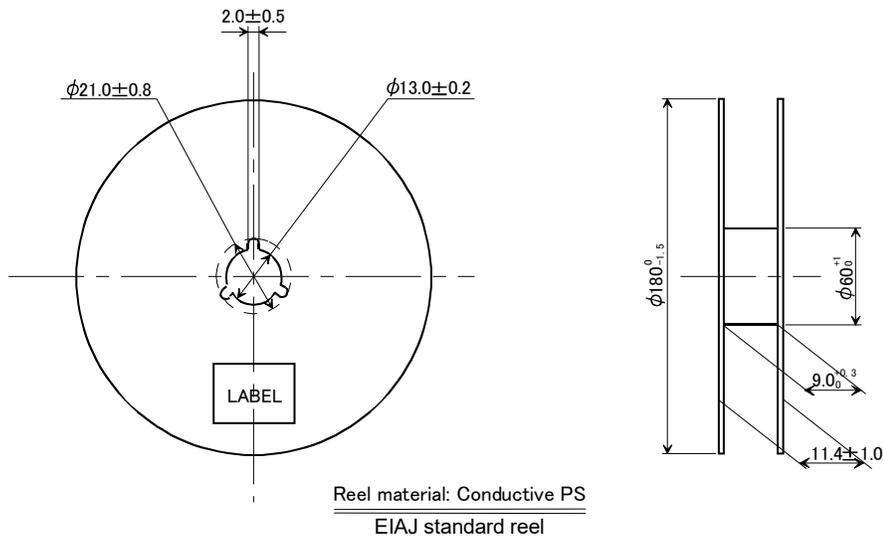
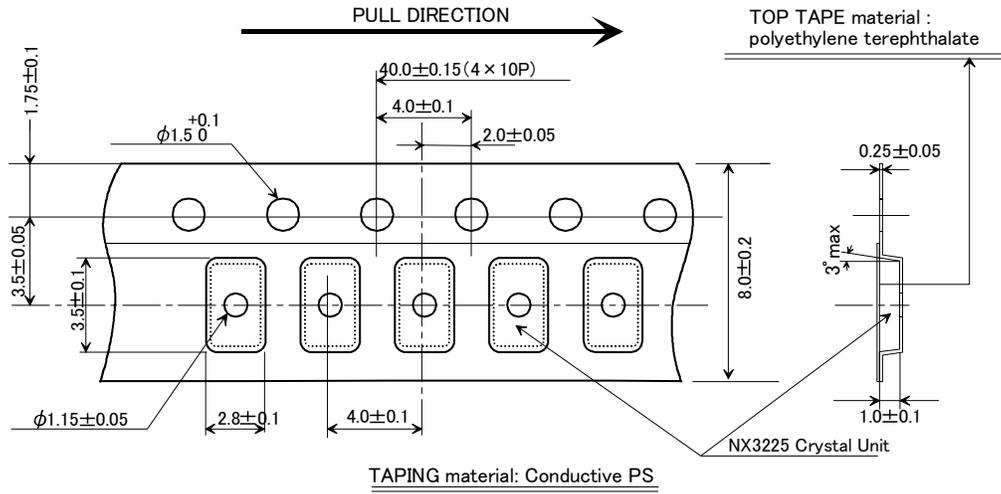
When using a soldering iron, press its tip on the part below the sealed part, avoiding the glass-sealed part

(otherwise, the glass will melt and air-tightness may be lost)



	Date of Revise	Charge	Approved	Reason	
D	7. Oct. 2019	H.Arimi	M.Sato	Change: Land pattern notation.	
	Date	Name	Third Angle Projection	Tolerance	Scale
Drawn	13.May.2010	R.Shariman	Dimension:mm	± 0.1	1 / 15
Designed	13.May.2010	R.Shariman	Title	Drawing No.	Rev.
Checked	13.May.2010	K.Komada			
Approved	13.May.2010	K.Ueki			
			NX3225GD	EXD14B-00474	D
			Dimension Drawing		

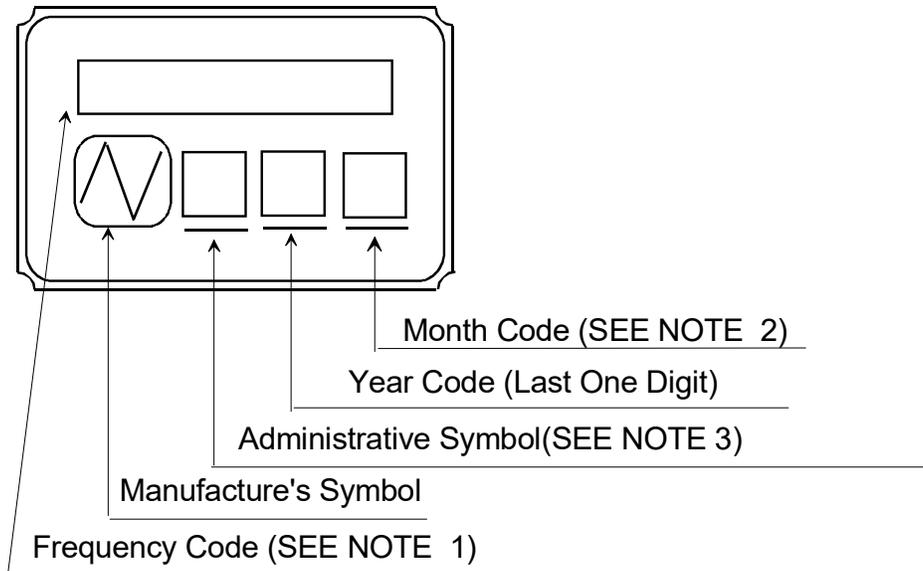
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3000pcs-Product Tape

	改訂日/ Date of Revise	担当/ Charge	承認/ Approved	理由/ Reason
D	21 Sep. 2022	K. Kawashima	H. Murakoshi	誤記訂正 / Correction of error.
	Date	Name	三角法/ Third Angle Projection	公差/ Tolerance
Drawn	30.Jun.2006	H.Yagishita	単位/ Dimension:mm	---
Designed	30.Jun.2006	H.Yagishita	名称/Title	図番/ Drawing No.
Checked	30.Jun.2006	K.Kubota	NX3225 シリーズ テープソグ・リール図 NX3225 Series Taping and Reel Spec.	EXK17B-00247
Approved	30.Jun.2006	T.Ishii		
				D

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NOTE

1. Frequency Code

Marking Frequency is consist of five digits, first five digits of Nominal Frequency

Example

Nominal Frequency	28.636363 MHz
Frequency Code	28.636

2. Month Code Table

Month	1 Jan.	2 Feb.	3 Mar.	4 Apr.	5 May.	6 Jun.	7 Jul.	8 Aug.	9 Sep.	10 Oct.	11 Nov.	12 Dec.
Month Code	1	2	3	4	5	6	7	8	9	X	Y	Z

3. Marking contents

Example

Administrative symbol	S
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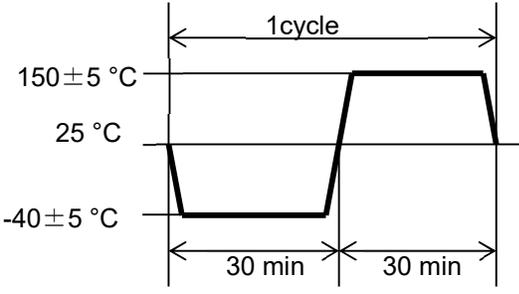
*Marking digits are not include a decimal point and dot mark.

	Date of Revise	Charge	Approved	Reason			
	Date	Name	Third Angle Projection	Tolerance	Scale		
Drawn	19.May.2008	R.Shariman	Dimension:mm		/		
Designed	19.May.2008	R.Shariman	Title Crystal Holder Marking		Drawing No. EXH11B-00392		
Checked	19.May.2008	M.Harada					Rev.
Approved	19.May.2008	K.Kubota					

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Reliability assurance item

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No.	Test item	Test methods	Spec. code
1	Drop	Devices are dropped from the height 75 cm onto iron plate. Execution 3 times random drops.	A
2	Shock	Acceleration: 49000 m/s ² Duration: 0.15 ms Half-Sine pulse 1 Shocks in 6 mutually perpendicular planes, Total 6 shocks	A
3	Vibration	Frequency range: 10 to 2000 Hz Amplitude or Acceleration: 1.52 mm or 196 m/s ² Sweep time: 20 min Test time: 4 h × 3	A
4	Electrode adherent strength	See remark (1)	B
5	Solderability	Pre-heat temperature : 150 °C Pre-heat Time : 60 ~ 120 s Peak temperature : 240 ± 5 °C 215 °C Over time : 10 ~ 30 s	C
6	Resistance to soldering heat	Pre-heat temperature : 150 °C Pre-heat time : 60 ~ 120 s Test temperature : 260 ± 5 °C Test time : 10 ± 1 s	A,B
7	Resistance to cold	Leave at -40 ± 2 °C for 1000 h	A
8	Resistance to heat	Leave at +150 ± 2 °C for 1000 h	A
9	Humidity	Device are left in temperature at +85 ± 2 °C with relative humidity of 80~85 % for 1000 h	A,D
10	Thermal shock	<p>Device are left into the following temperature cycle as shown in (Figure1) for 1000 consecutive cycle.</p>  <p>(Figure1)</p>	A,B

Reliability assurance item

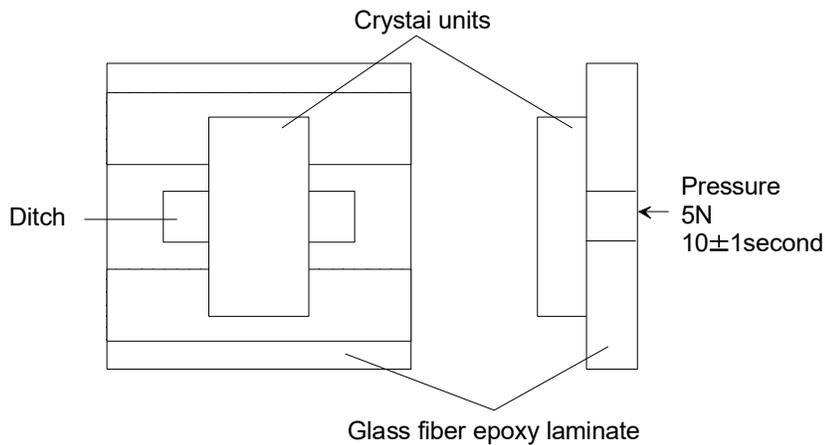
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Spec. code	Specification
A	$\Delta f/f \leq \pm 20$ ppm $\Delta CI/CI \leq \pm 40$ % or 5 Ω make use larger value
B	After testing unless cracking of materials view of eyes and unless break of seal.
C	The leads shall acquire a new solder coat cover at 90 % of immersed area.
D	Insulation resistance shall be greater than 500 M Ω

Remark (1) Electrode adherent strength.

1) Test method condition

Using the solder, soldering Iron or reflow soldering bath shall be used for soldering on test fixture (Glass fiber epoxy laminate : Thickness 1.6mm+/-0.2mm) shown below.

**2) Specified value**

No peel of electrode, no crack, no other abnormality

Recommendation reflow condition

1.IR reflow condition

